

**AMENDMENTS TO SPECIFICATION**

Please amend paragraph <sup>55</sup>~~57~~ as follows:

7/23/08  
T.T.

It should be noted, however, that a method for electrically connecting the FPC 200 and the PCBs 115 and ~~224~~ 124 of the camera module for mobile communication terminal of the present invention is not limited to the aforesaid method. For example, the connection of the FPC 200 and the PCBs 115 and ~~224~~ 124 may be carried out using anisotropic conductive film, anisotropic conductive paste, or adhesive resin. The anisotropic conductive film or the anisotropic conductive paste is obtained by dispersing conductive particles on resin film or resin paste and thermally pressing the resin film having the conductive particles dispersed thereon or the resin paste having the conductive particles dispersed thereon. The anisotropic conductive film or the anisotropic conductive paste has a one-way conductivity and an insulating property in the direction perpendicular to the conductive direction so that the film or the paste can be electrically connected. When the connection of the FPC 200 and the PCBs 115 and ~~224~~ 124 is carried out using the anisotropic conductive film or the anisotropic conductive paste, the circuit conductors of the FPC and the circuit conductors of the PCB are electrically connected to each other via the conductive particles in the anisotropic conductive film or the anisotropic conductive paste. When the connection of the FPC 200 and the PCBs 115 and ~~224~~ 124 is carried out using the adhesive resin, which contains no conductive particles therein, the circuit conductors of the FPC are directly connected to the circuit conductors of the PCB.